

C0805X159DDTACTU

Aliases (C0805X159DDTAC7800)

SMD Comm X8G HVHT150C Flex, Ceramic, 1.5 pF, +/-0.5 pF, 1,000 VDC, X8G, SMD, MLCC, High Voltage, High Temperature, Ultra-Stable, 0.6 mm, 0805 / 2012



Click [here](#) for the 3D model.

General Information

Series	SMD Comm X8G HVHT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Voltage, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
Typical Component Weight	14 mg
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	1.5 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	+/-0.5 pF
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1,200 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MHz 1.0Vrms
Dissipation Factor	0.1% 1MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

Dimensions

L	2mm +/-0.3mm
W	1.25mm +/-0.3mm
T	1.25mm +/-0.15mm
S	0.6mm MIN
B	0.5mm +/-0.25mm
Case Code (EIA / mm)	0805 / 2012

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500

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